### SPECIFICATIONS

### Dot matrix Display点阵产品规格书



### 上海鼎晖科技股份有限公司

SHANGHAI TOPLITE TECHNOLOGY CO., LTD.

www.ledtoplight.com.cn www.ledtoplite.com



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

## TECHNICAL DATA SHEETTOP-CA-788BSRFOR \$\Phi\$ 1.9MM 8\*8 dot matrix digit

1/6

#### **1. PRODUCT INTRODUCTION**

- \* Low power requirement,
- X Solid state reliability.
- ✗ Wide viewing angle.
- \* Easy mounting on P.C. boards.
- ※ RHOS compliant.

#### 2. FEATURES

- ℜ TOP-CA-788BSR is aΦ1.9MM 8\*8 DOT MATRIX.
- % This device is made with white dots and black surface.

#### 3. APPLICATION

- ✗ Digital readout display.
- ✗ Instrument panels.
- i ≫ Elevator.

PART NO.	SIZE	CHIP EMITTED COLOR	FACE COLOR
TOP-CA-788BSR	Ф1.9 <b>ММ 8*8</b>	Super Red	Black

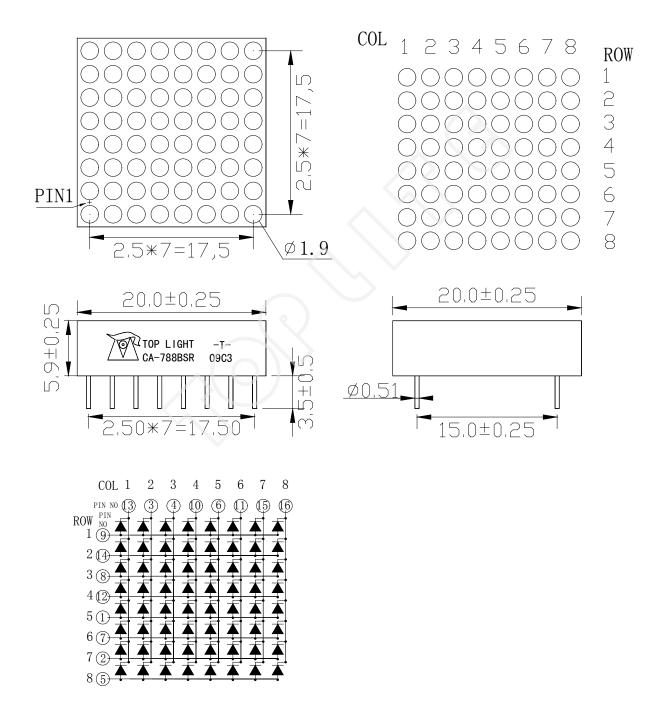


SHANGHAI TOPLITE TECHNOLOGY CO.,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

## TECHNICAL DATA SHEETTOP-CA-788BSRFOR \$\Phi\$ 1.9MM 8\*8 dot matrix digit

2/6

#### 4. PACKAGE DIMENSIONS & CIRCUIT DIAGRAM



١



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

# TECHNICAL DATA SHEETTOP-CA-788BSRFOR Ф 1.9MM 8\*8 DOT MATRIX DIGIT

3/6

#### 5. ELECTRICAL/OPTICAL CHARACTERISTIC

#### 5-1. ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

PARAMETER	SYMBOL	VALUE	UNIT
Reverse Voltage	V <sub>R</sub>	5	V/dot
Forward Current	$I_{\rm F}$	30	mA/dot
Peak Forward Current (1/10 Duty Cycle)	I <sub>PEAK</sub>	120	mA/dot
Power Dissipation	P <sub>D</sub>	80	mW/dot
Operating Temperature Range	T <sub>A</sub>	- 25 ~ + 85	°C
Storage Temperature Range	T <sub>STG</sub>	- 30 ~ + 85	°C
Solder Temperature	Tsol	260/3	°C/s

#### 5-2. ELECTRICAL-OPTICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Luminous Intensity	Iv	S	17550	21938	26325	ucd	I <sub>F</sub> =10mA
		Т	26326	32908	39489		
		U	39490	49363	59235		
Forward Voltage	V <sub>F</sub>		1.80	2.10	2.40	v/dot	I <sub>F</sub> =20mA
Chromatographer	λ	p p	-	622	-	nm	I <sub>F</sub> =20mA
Spectral Line Half-Width	Δλ		-	20	-	nm	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>		-	-	20	uA	V <sub>R</sub> =5v

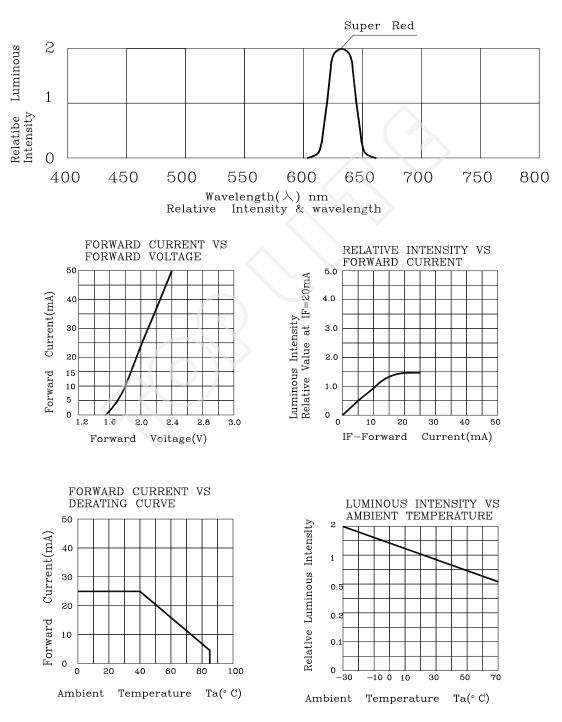


SHANGHAI TOPLITE TECHNOLOGY CO,,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

# **TECHNICAL DATA SHEETTOP-CA-788BSR**FOR $\Phi$ 1.9MM 8\*8 dot matrix digit

4/6

#### **5-3. OPTICAL CHARACTERISTIC CURVES**





SHANGHAI TOPLITE TECHNOLOGY CO.,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

# TECHNICAL DATA SHEETTOP-CA-788BSRFOR Ф 1.9MM 8\*8 DOT MATRIX DIGIT

#### 6. QUALITY CONTROL AND ASSURANCE

CLASSIFICATION	TEST ITEM	TEST CONDITION		
	OPERATION LIFE	Ta=under room temperature If=12mA-25mA per segment or Ip=80mA/duty=1/8,Pw=1.25mS Ip=160mA/duty=1/16,Pw=1.mS(DOT) Test time=1000HRS(-24HRS+72HRS)		
ENDUTRANCE TEST	MOISTURE	Ta=65 °C $\pm$ 5 °C RH=90-95% Test time=240HRS $\pm$ 2HRS		
	HIGH TEMPERATURE HIGH HUMIDITY REVERSE BIAS	Ta=65℃±5℃ RH=90-95% VR=5V Test time=500hrs(-24HRS+48HRS)		
	HIGH TEMPERATURE STORAGE	To evaluate device's durability for long term storage in high temperature Ta= $85^{\circ}C\pm5^{\circ}C$ Test time=1000HRS(-24HRS+72HRS)		
	LOW TEMPERATURE STORAGE	Ta=-35°C±5°C Test time=1000HRS(-24HRS+72HRS)		
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	Ta=85°C $\sim$ 25°C $\sim$ -35°C time=30min 5min 30min 5min Cycle test:10cycles		
	THERMAL SHOCK	Ta=85°C±5°C $\sim$ -35°C±5°C time=10min 10min Cycle test:10cycles		
	SOLOER RESISTANCE	T.sol=260°C±5°C time=10±1sec		
	SOLOER ABILITY	T.sol=230°C±5°C time=5±1sec		



SHANGHAI TOPLITE TECHNOLOGY CO,,LTD. Http://www.ledtoplight.com.cn www.ledtoplite.com

## TECHNICAL DATA SHEETTOP-CA-788BSRFOR \$\Phi\$ 1.9MM 8\*8 DOT MATRIX DIGIT

6/6

#### 7. SOLDERING CONDITIONS

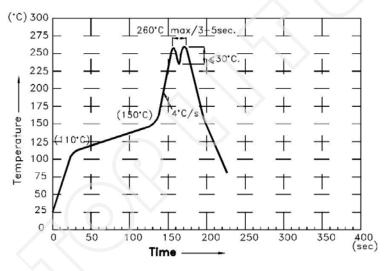
The recommended conditions for soldering are as follows.

Because the component is made with epoxy resin, the units are susceptible to heat. Therefore, the preheating and soldering temperatures should be kept as low as possible to avoid damage.

7-1. Manual Soldering Conditions(with 1.5mm Iron tip ).
Iron Tip Temperature: 350°C Max, Time: 3s Max.
Position: The iron should be situated at least 2mm away

Position: The iron should be situated at least 2mm away from the root of the leads.

7-2. Through the Wave Soldering Conditions Wave Soldering Profile For Lead-free Through-hole LED.



- 7-3. Soldering General Notes:
  - a. Recommend manual soldering to be used only for repair and rework purposes. The soldering iron should not exceed 30W in power. The tip of the soldering iron should not touch the reflector case to avoid heat-damage.
  - b. Maintain the pre-heat and peak temperatures with dip units as low as possible and the times as short as is feasible, since the products are susceptible to heat during flow soldering.
  - c. After soldering, least three minutes for the component to cool to room temperature before further operations.
  - d. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with toplight for compatibility.